



US00D397093S

**United States Patent** [19]  
**Kim**

[11] **Patent Number:** **Des. 397,093**  
[45] **Date of Patent:** **\*\*Aug. 18, 1998**

[54] **PRINTED CIRCUIT BOARD WITH MOUNTED COMPONENTS**  
[76] **Inventor:** **Il Kim**, 3400 Avenue of the Arts, A-115, Costa Mesa, Calif. 92626  
[\*\*] **Term:** **14 Years**

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[57] **CLAIM**

The ornamental design for the printed circuit board with mounted components, as shown and described.

**DESCRIPTION**

[21] **Appl. No.:** **74,329**  
[22] **Filed:** **Jul. 30, 1997**  
[51] **LOC (6) Cl.** ..... **13-03**  
[52] **U.S. Cl.** ..... **D13/182**  
[58] **Field of Search** ..... **D13/182; 361/380, 361/384, 392, 395, 397, 399**

FIG. 1 is a top plan view of the printed circuit board with mounted components;  
FIG. 2 is a bottom plan view of the printed circuit board with mounted components;  
FIG. 3 is a front elevational view of the printed circuit board with mounted components;  
FIG. 4 is a rear elevational view of the printed circuit board with mounted components;  
FIG. 5 is a left side elevational view of the printed circuit board with mounted components; and,  
FIG. 6 is a right side elevational view of the printed circuit board with mounted components.

[56] **References Cited**

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**1 Claim, 2 Drawing Sheets**

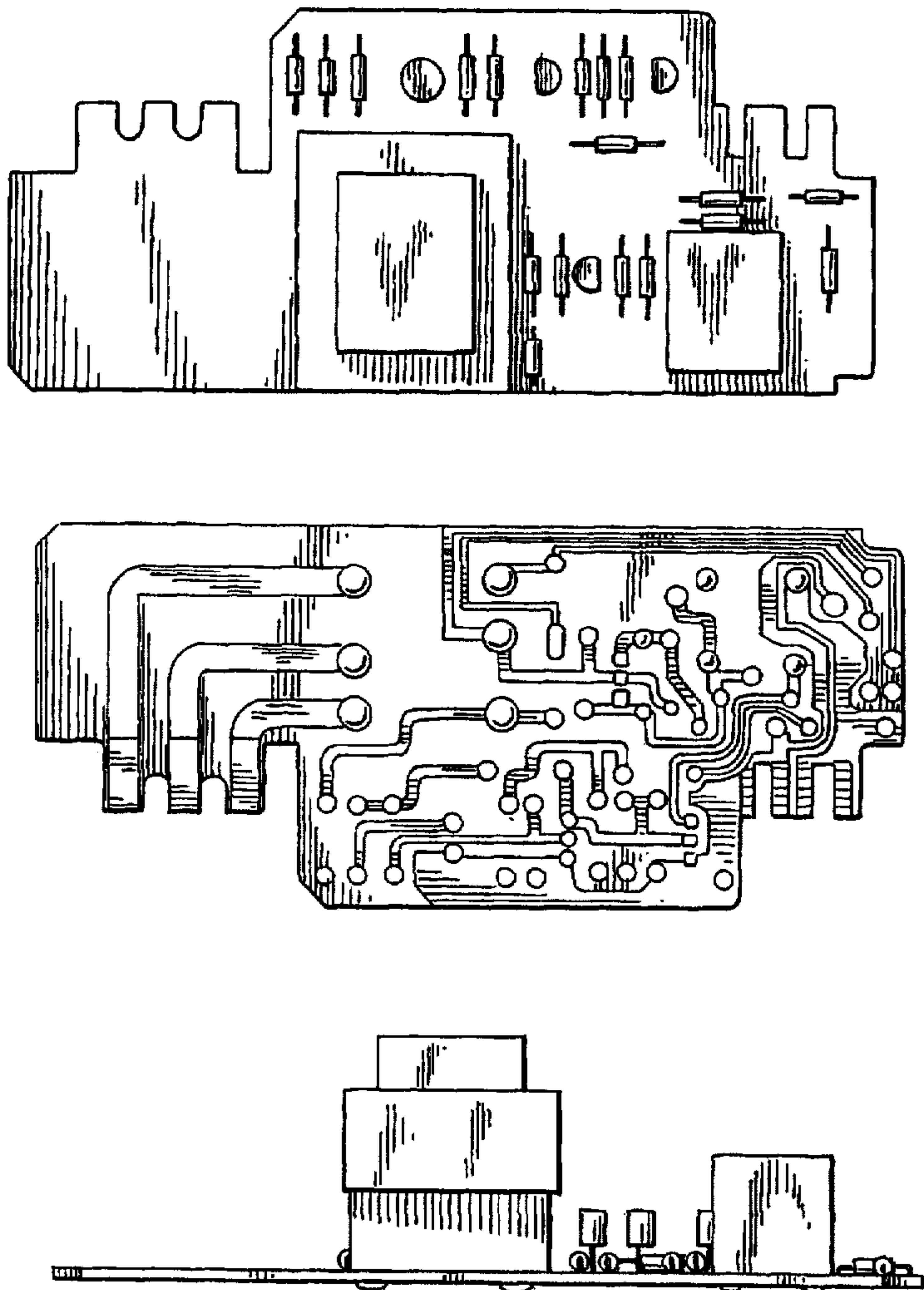


FIG. 1

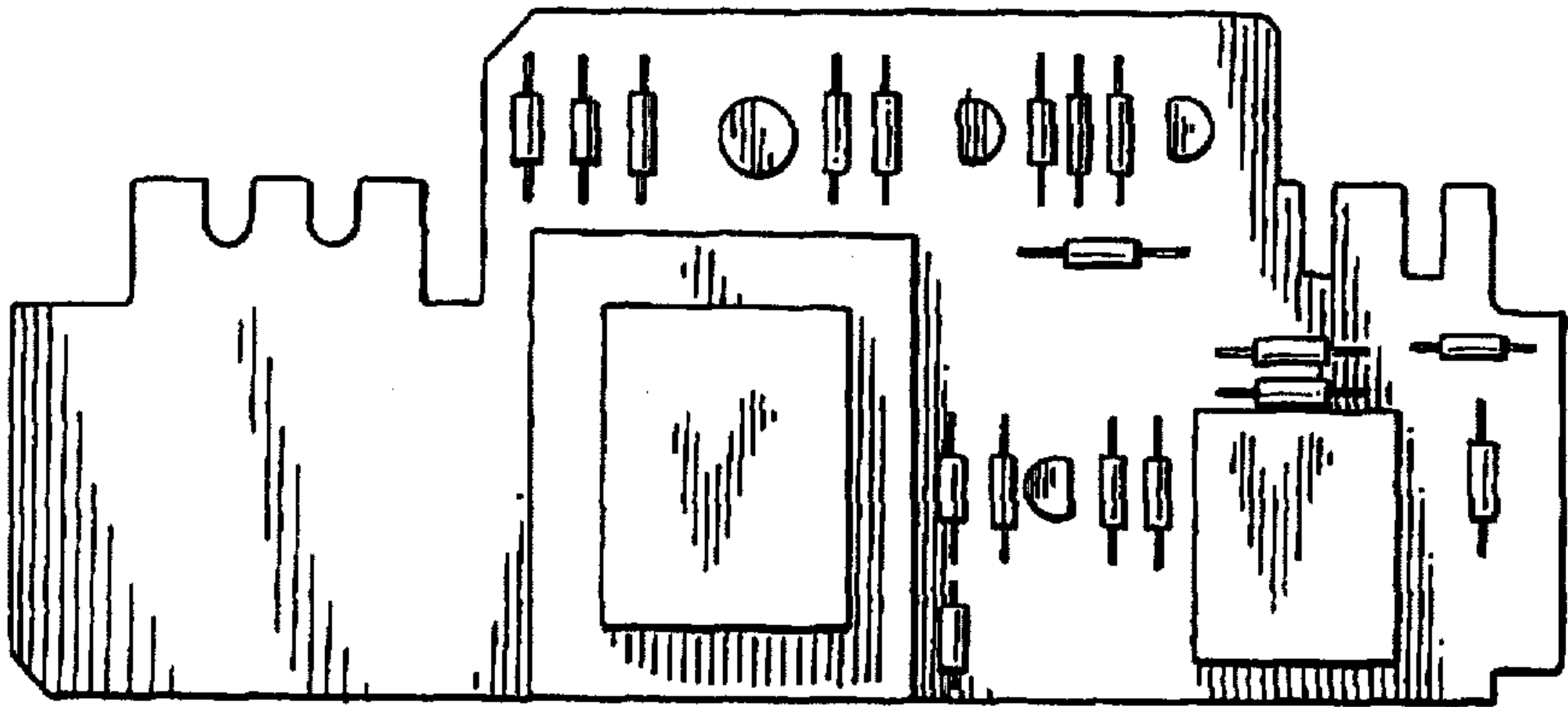


FIG. 2

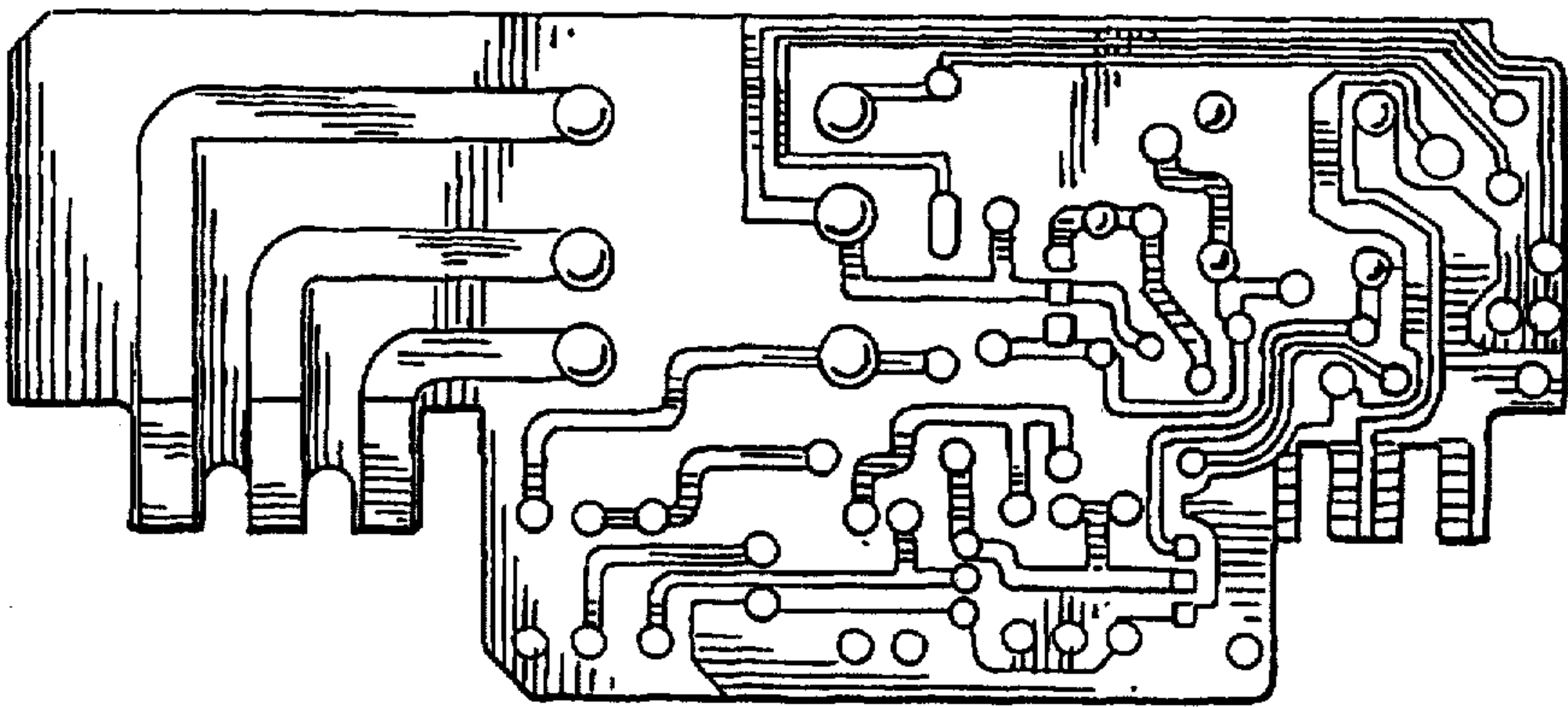


FIG. 3

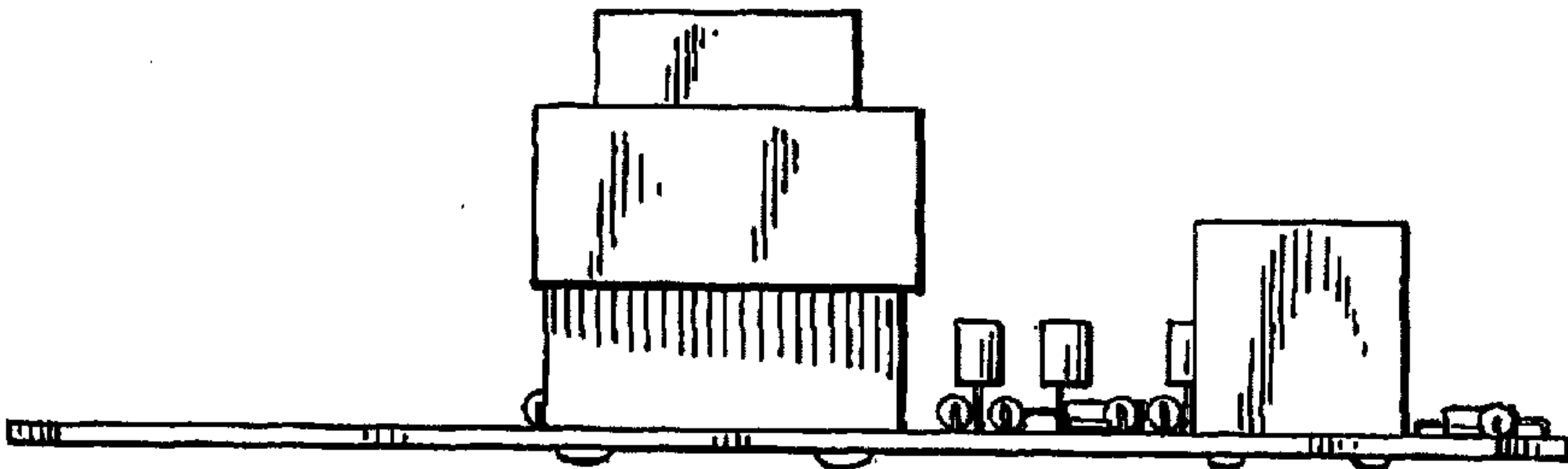


FIG. 4

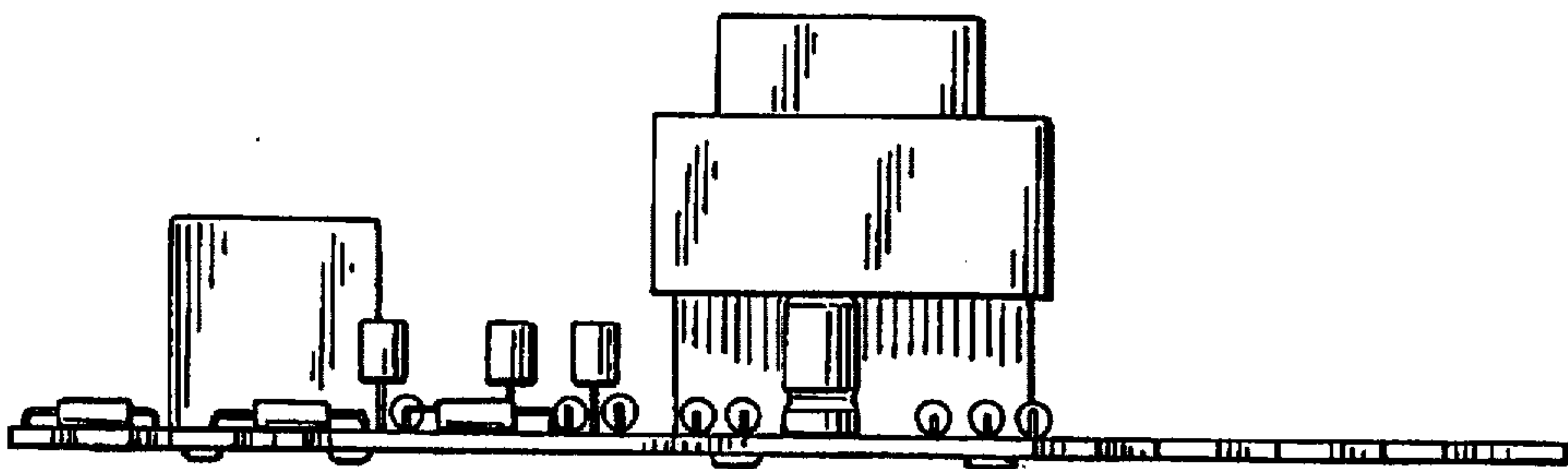


FIG. 5

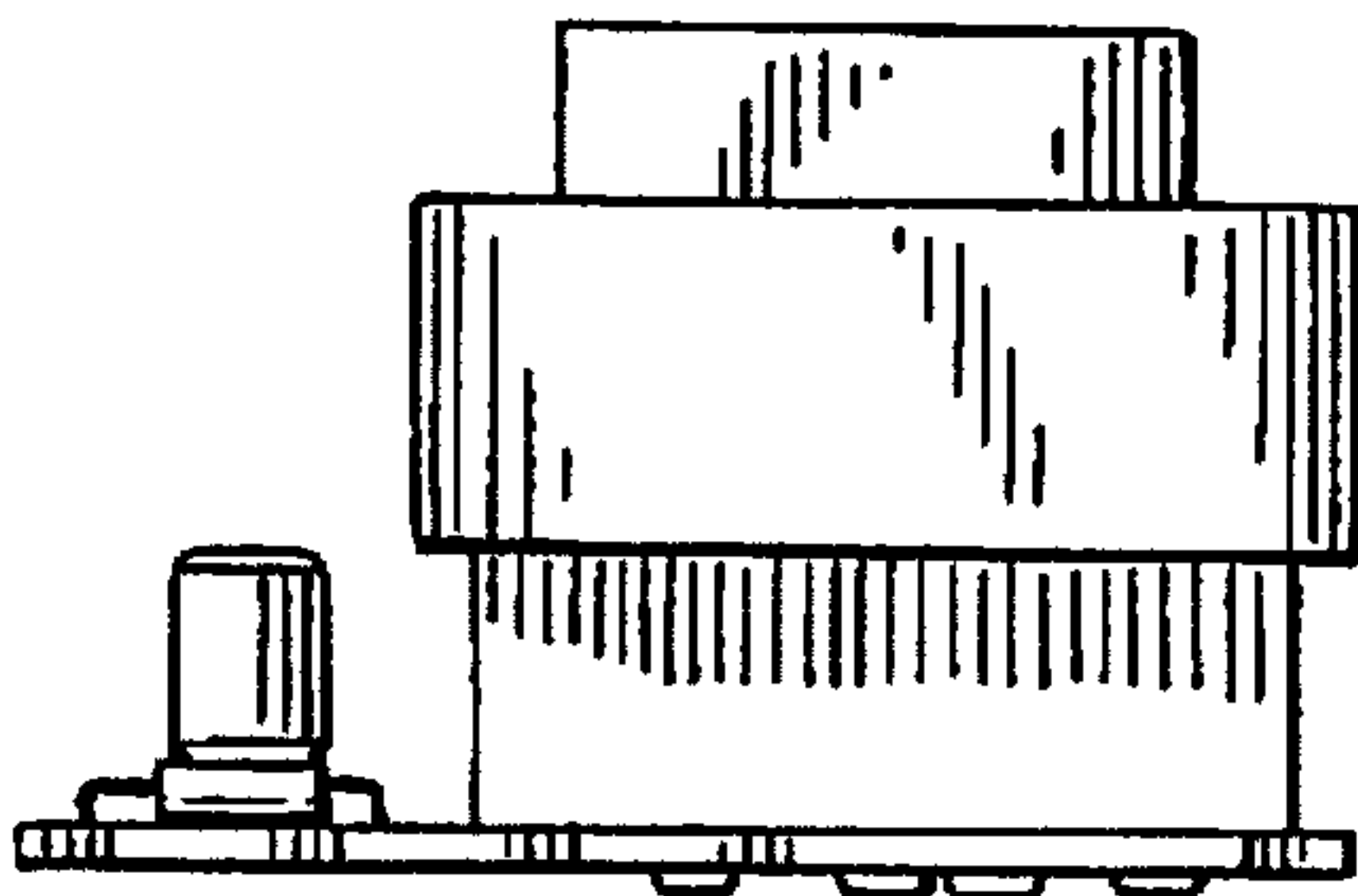


FIG. 6

